

## WHAT IS CLAIMED IS:

1. A method of forming an insulating film comprising silicon oxide formed over a glass substrate,

wherein the insulating film includes halogen at a concentration of  $5 \times 10^{20}$  cm<sup>-3</sup> or less and carbon at a concentration of  $5 \times 10^{19}$  cm<sup>-3</sup> or less which are detected by second ion mass spectroscopy.

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- 2. A method according to claim 1, wherein the halogen is fluorine or chlorine.
- 3. A method according to claim 1, wherein the insulating film includes carbon at a concentration of 1x10<sup>18</sup> cm<sup>-3</sup> or less which is detected by the second ion mass spectroscopy.
  - 4. A method according to claim 1, wherein said insulating film is a gate insulating film.
  - 5. A method according to claim 1 wherein the insulating film is an insulating film in a thin film transistor.
    - 6. A method according to claim 1, wherein the insulating film covers an even surface over the glass substrate.
    - 7. A method according to claim 1, wherein the insulating film includes halogen at a concentration of  $1 \times 10^{17}$  cm<sup>-3</sup> or more.
- 8. A method of producing a semiconductor device, said method comprising the steps of:





forming a crystalline semiconductor island formed over a glass substrate; and

forming an insulating film including silicon oxide formed to cover the crystalline semiconductor island,

wherein the insulating film includes halogen at a concentration of  $5x10^{20}$  cm<sup>-3</sup> or less and carbon at a concentration of  $5x10^{19}$  cm<sup>-3</sup> or less.

- 9. A method according to claim 8, wherein the concentrations of halogen and carbon are detected by secondary ion mass spectroscopy.
- 10. A method according to claim 8, wherein the halogen is fluorine or chlorine.
- 11. A method according to claim 8, wherein the insulating film is formed by plasma chemical vapor deposition using an organic silane.
- 12. A method according to claim 8, wherein the insulating film includes halogen at a concentration of 1 x  $10^{17}$  cm<sup>-3</sup> or more.

13. A method of fabricating a thin film transistor, said method comprising the steps of

forming a crystalline semiconductor island formed over a glass substrate;

forming a sill con oxide film formed to cover the crystalline semiconductor island; and

forming a conductive film including at least one of aluminum, titanium, and titanium nitride, said conductive film being formed on the silicon oxide film,

wherein the silicon oxide film includes halogen at a concentration of  $5 \times 10^{20}$  cm<sup>-3</sup> or less and carbon at a concentration of  $5 \times 10^{19}$  cm<sup>-3</sup> or less.

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- 14. A method according to claim 13, wherein the halogen is fluorine or chlorine.
- 15. A method according to claim 13, wherein the silicon oxide film is formed by plasma chemical vapor deposition using an organic silane.
- 5 16. A method according to claim 13, wherein the silicon oxide film includes halogen at a concentration of  $1 \times 10^{17}$  cm<sup>-3</sup> or more.
  - 17. A method of fabricating a thin film transistor, said method comprising the steps of:

forming a crystalline semiconductor island formed over a glass substrate;

forming a gate insulating film including silicon oxide formed on the crystalline semiconductor island; and

forming a gate electrode formed on the insulating film, wherein the gate insulating film includes halogen at a concentration of  $5x10^{20}$  cm<sup>-3</sup> or less and carbon at a concentration of  $5x10^{19}$  cm<sup>-3</sup> or less.

18. A method according to claim 17, wherein the halogen is fluorine or chlorine.

- 19. A method according to claim 17, wherein the gate insulating film is formed by plasma chemical vapor deposition using an organic silane.
- 20. A method according to claim 17, wherein the gate insulating film includes halogen at a concentration of  $1 \times 10^{17}$  cm<sup>-3</sup> or more.

